



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Nishant Sinha

Serial No.: 10/668,914

Filed: September 23, 2003

For: PROCESS AND INTEGRATION
SCHEME FOR FABRICATING
CONDUCTIVE COMPONENTS,
THROUGH-VIAS AND
SEMICONDUCTOR COMPONENTS
INCLUDING CONDUCTIVE THROUGH-
WAFER VIAS

Confirmation No.: 2525

Examiner: W. Lindsay Jr.

Group Art Unit: 2812

Attorney Docket No.: 2269-5859US
(02-0390.00/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

September 20, 2005
Date


Signature

Erika Gandre
Name (Type/Print)

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Examiner:

This Amendment is being filed in response to the Office Action mailed on May 20, 2005, the three month shortened statutory period for response to which expired on August 20, 2005.

This Amendment is being filed with a petition for a one month extension of time and the appropriate fee.

Amendments to the claims appear in the listing of the claims that begins on page 2 of this paper; and

Remarks start at page 5 of this paper.